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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application

Applicant(s) Parida et al.
Docket No.: YOR920030299US1
Serial No.: 10/661,322
Filing Date: September 12, 2003
Group: 2129
Examiner: Peter D. Coughlan

I hereby certify that this paper is being deposited on this date with the U.S. Postal Service as first class mail addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

Signature: Bobbette Blake Date: June 30, 2006

Title: Discovering Permutation Patterns

TRANSMITTAL LETTER

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Submitted herewith is an Amendment and Response to an Office Action relating to the above-identified patent application.

There is no additional claim fee due in connection with the Amendment.

In the event of non-payment or improper payment of a required fee, the Commissioner is authorized to charge or to credit **IBM Corporation Deposit Account No. 50-0510** as required to correct the error. A duplicate copy of this letter is enclosed.

Respectfully submitted,

Kevin M. Mason

Dated: June 30, 2006

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15

AMENDMENT AND RESPONSE TO OFFICE ACTION

20 Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

25 Sir:

In response to the outstanding Office Action, dated April 6, 2006, please amend the above-identified patent application as follows.